



## Description

The AOD2922 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

## General Features

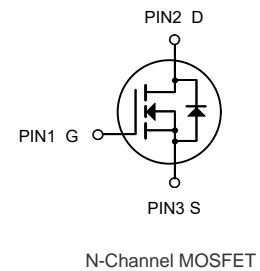
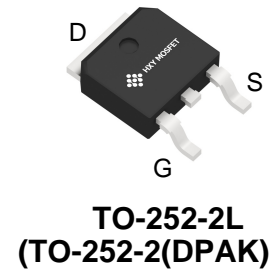
$V_{DS} = 100V, I_D = 15A$

$R_{DS(ON)} < 112m\Omega @ V_{GS} = 10V$

## Application

Power switch

DC/DC converters



N-Channel MOSFET

## Package Marking and Ordering Information

| Product ID | Pack                      | Brand      | Qty(PCS) |
|------------|---------------------------|------------|----------|
| AOD2922    | TO-252-2L(TO-252-2(DPAK)) | HXY MOSFET | 2500     |

## Absolute Maximum Ratings ( $T_c = 25^\circ C$ unless otherwise noted)

| Symbol                    | Parameter  | Rating     | Units        |
|---------------------------|--|------------|--------------|
| $V_{DS}$                  | Drain-Source Voltage                             | 100        | V            |
| $V_{GS}$                  | Gate-Source Voltage                              | $\pm 20$   | V            |
| $I_D @ T_c = 25^\circ C$  | Continuous Drain Current, $V_{GS} @ 10V^1$       | 15         | A            |
| $I_D @ T_c = 100^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$       | 7.7        | A            |
| $I_{DM}$                  | Pulsed Drain Current <sup>2</sup>                | 24         | A            |
| EAS                       | Single Pulse Avalanche Energy <sup>3</sup>       | 6.1        | mJ           |
| $I_{AS}$                  | Avalanche Current                                | 11         | A            |
| $P_D @ T_c = 25^\circ C$  | Total Power Dissipation <sup>3</sup>             | 34.7       | W            |
| $T_{STG}$                 | Storage Temperature Range                        | -55 to 150 | $^\circ C$   |
| $T_J$                     | Operating Junction Temperature Range             | -55 to 150 | $^\circ C$   |
| $R_{\theta JA}$           | Thermal Resistance Junction-ambient <sup>1</sup> | 62         | $^\circ C/W$ |
| $R_{\theta JC}$           | Thermal Resistance Junction-Case <sup>1</sup>    | 3.6        | $^\circ C/W$ |



**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**

| Symbol                       | Parameter                                      | Conditions   | Min. | Typ.  | Max.      | Unit                |
|------------------------------|--|--|------|-------|-----------|---------------------|
| $BV_{DSS}$                   | Drain-Source Breakdown Voltage                 | $V_{GS}=0V$ , $I_D=250\mu A$                               | 100  | ---   | ---       | V                   |
| $\Delta BV_{DSS}/\Delta T_J$ | BVDSS Temperature Coefficient                  | Reference to $25^\circ\text{C}$ , $I_D=1mA$                | ---  | 0.098 | ---       | $V/^\circ\text{C}$  |
| $R_{DS(ON)}$                 | Static Drain-Source On-Resistance <sup>2</sup> | $V_{GS}=10V$ , $I_D=10A$                                   | ---  | 100   | 112       | $m\Omega$           |
|                              |  | $V_{GS}=4.5V$ , $I_D=8A$                                   | ---  | 117   | 130       | $m\Omega$           |
| $V_{GS(th)}$                 | Gate Threshold Voltage                         |  | 1.0  | ---   | 2.5       | V                   |
|                              |  | $V_{GS}=V_{DS}$ , $I_D=250\mu A$                           |      |       |           |                     |
| $\Delta V_{GS(th)}$          | $V_{GS(th)}$ Temperature Coefficient           |  | ---  | -4.57 | ---       | $mV/^\circ\text{C}$ |
| $I_{DSS}$                    | Drain-Source Leakage Current                   | $V_{DS}=80V$ , $V_{GS}=0V$ , $T_J=25^\circ\text{C}$        | ---  | ---   | 1         | $\mu A$             |
|                              |  | $V_{DS}=80V$ , $V_{GS}=0V$ , $T_J=55^\circ\text{C}$        | ---  | ---   | 5         |                     |
| $I_{GSS}$                    | Gate-Source Leakage Current                    | $V_{GS}=\pm 20V$ , $V_{DS}=0V$                             | ---  | ---   | $\pm 100$ | nA                  |
| $g_{fs}$                     | Forward Transconductance                       | $V_{DS}=5V$ , $I_D=10A$                                    | ---  | 13    | ---       | S                   |
| $R_g$                        | Gate Resistance                                | $V_{DS}=0V$ , $V_{GS}=0V$ , $f=1MHz$                       | ---  | 2     | ---       | $\Omega$            |
| $Q_g$                        | Total Gate Charge (10V)                        |  | ---  | 26.2  | ---       | nC                  |
| $Q_{gs}$                     | Gate-Source Charge                             | $V_{DS}=80V$ , $V_{GS}=10V$ , $I_D=10A$                    | ---  | 4.6   | ---       |                     |
| $Q_{gd}$                     | Gate-Drain Charge                              |  | ---  | 5.1   | ---       |                     |
| $T_{d(on)}$                  | Turn-On Delay Time                             |  | ---  | 4.2   | ---       | ns                  |
| $T_r$                        | Rise Time                                      | $V_{DD}=50V$ , $V_{GS}=10V$ ,<br>$R_G=3.3$                 | ---  | 8.2   | ---       |                     |
| $T_{d(off)}$                 | Turn-Off Delay Time                            | $I_D=10A$  | ---  | 35.6  | ---       |                     |
| $T_f$                        | Fall Time                                      |  | ---  | 9.6   | ---       |                     |
| $C_{iss}$                    | Input Capacitance                              |  | ---  | 1535  | ---       | pF                  |
| $C_{oss}$                    | Output Capacitance                             | $V_{DS}=15V$ , $V_{GS}=0V$ , $f=1MHz$                      | ---  | 60    | ---       |                     |
| $C_{rss}$                    | Reverse Transfer Capacitance                   |  | ---  | 37    | ---       |                     |
| $I_S$                        | Continuous Source Current <sup>1,5</sup>       |  | ---  | ---   | 12        | A                   |
| $I_{SM}$                     | Pulsed Source Current <sup>2,5</sup>           | $V_G=V_D=0V$ , Force Current                               | ---  | ---   | 24        | A                   |
| $V_{SD}$                     | Diode Forward Voltage <sup>2</sup>             | $V_{GS}=0V$ , $I_S=1A$ , $T_J=25^\circ\text{C}$            | ---  | ---   | 1.2       | V                   |
| $t_{rr}$                     | Reverse Recovery Time                          | $I_F=10A$ , $dI/dt=100A/\mu s$ ,<br>$T_J=25^\circ\text{C}$ | ---  | 37    | ---       | nS                  |
| $Q_{rr}$                     | Reverse Recovery Charge                        |  | ---  | 27.3  | ---       | nC                  |

Note :

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 20Z copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is  $V_{DD}=25V$ ,  $V_{GS}=10V$ ,  $L=0.1mH$ ,  $I_{AS}=11A$
- 4.The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
- 5 .The data is theoretically the same as  $I_D$  and  $I_{DM}$  , in real applications , should be limited by total power dissipation.



## Typical Characteristics

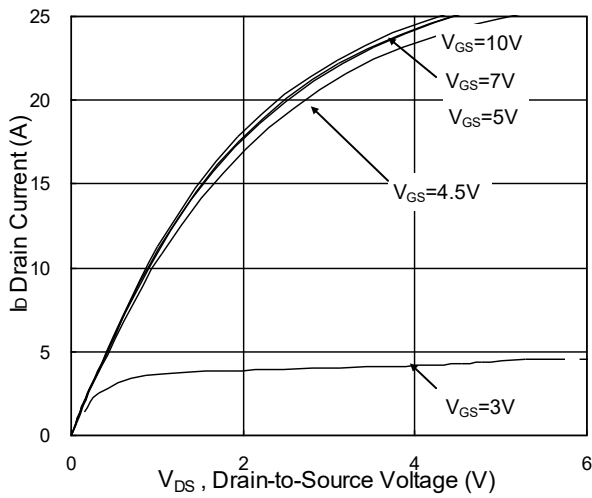


Fig.1 Typical Output Characteristics

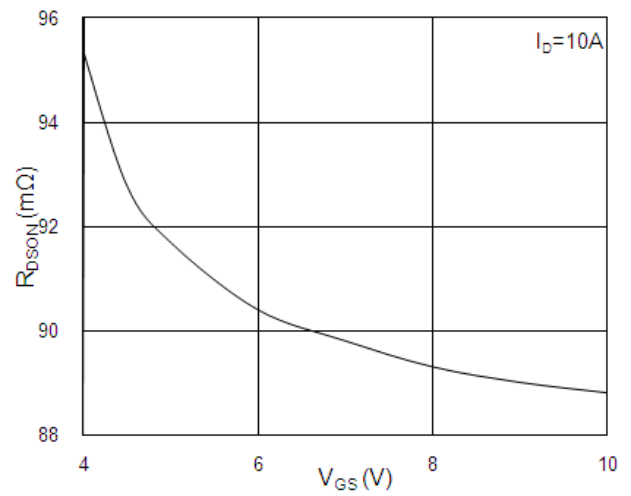


Fig.2 On-Resistance vs. Gate-Source

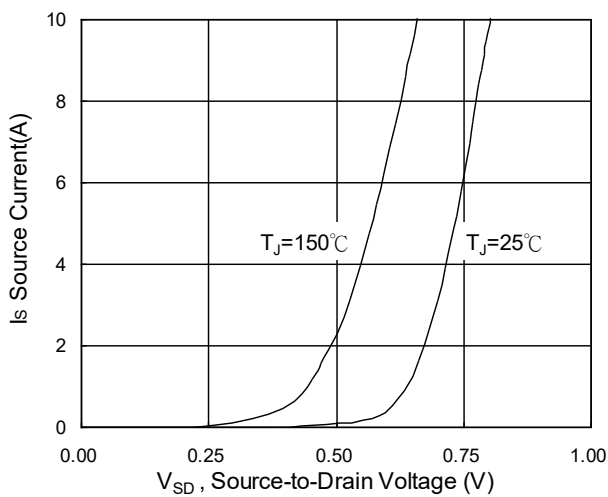


Fig.3 Forward Characteristics Of Reverse

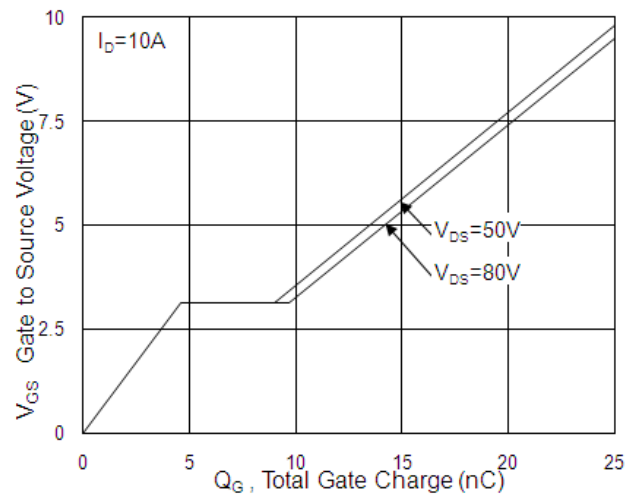


Fig.4 Gate-Charge Characteristics

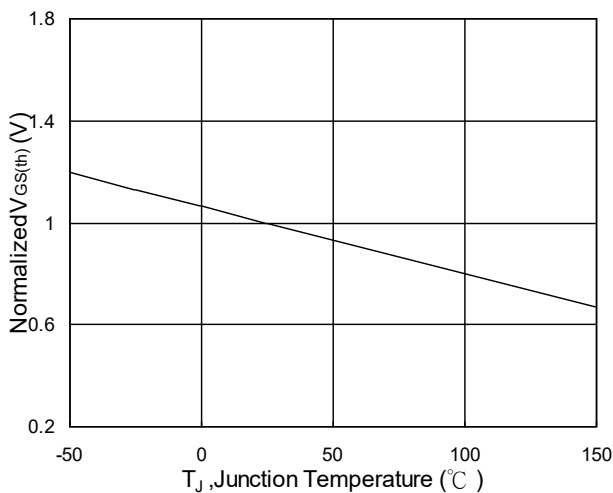


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$

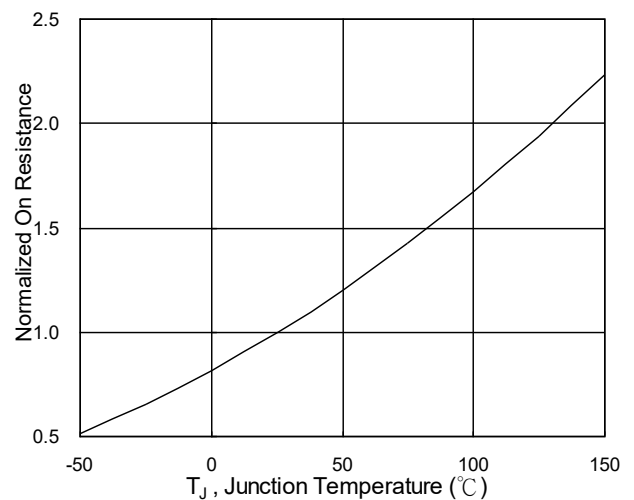


Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$

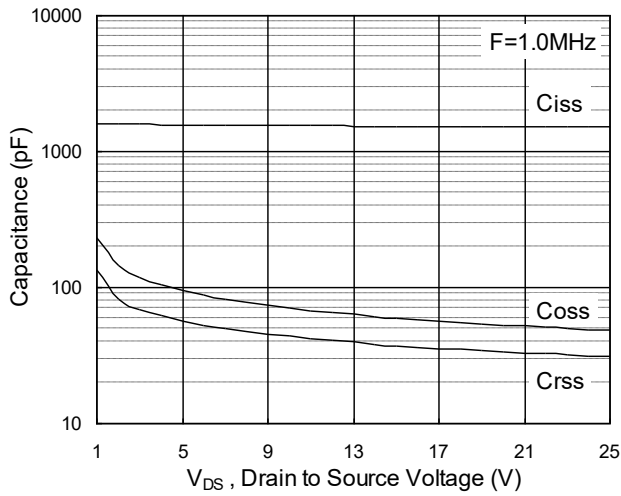


Fig.7 Capacitance

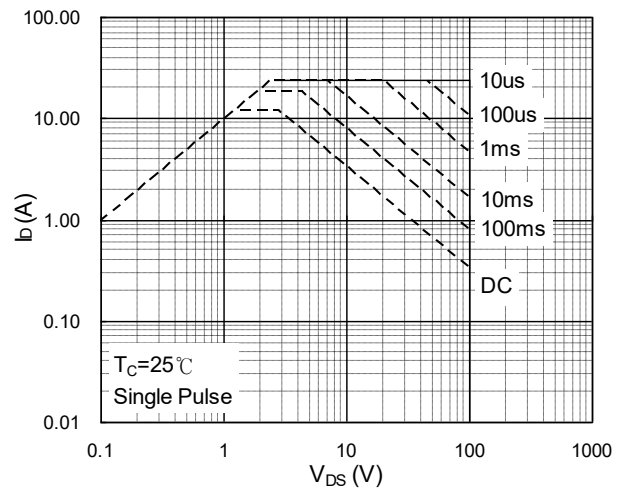


Fig.8 Safe Operating Area

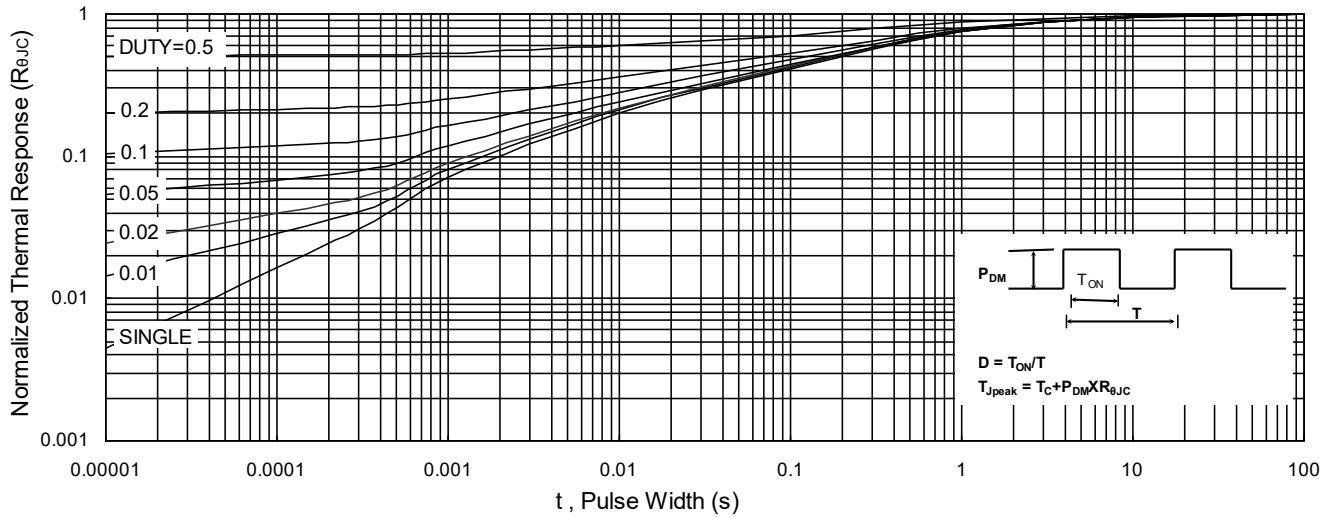


Fig.9 Normalized Maximum Transient Thermal Impedance

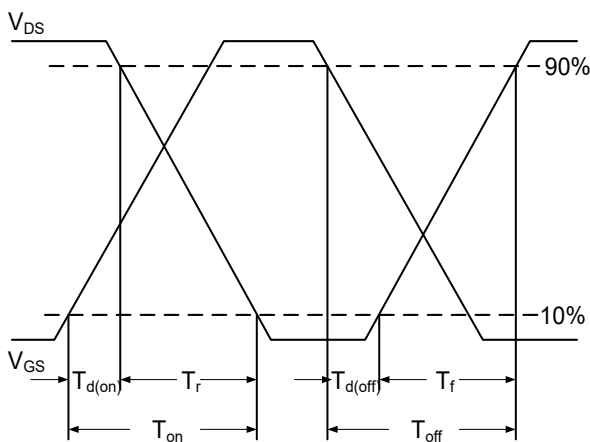


Fig.10 Switching Time Waveform

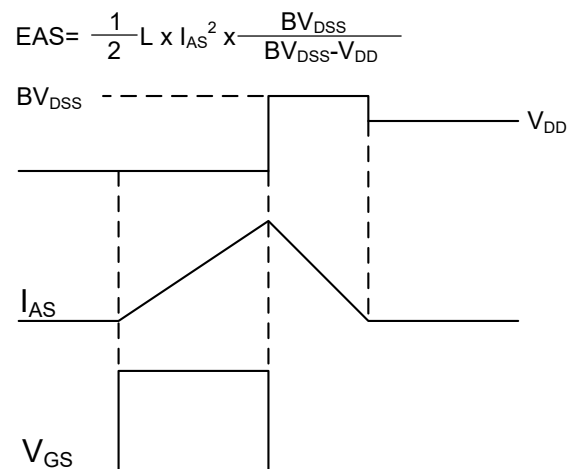
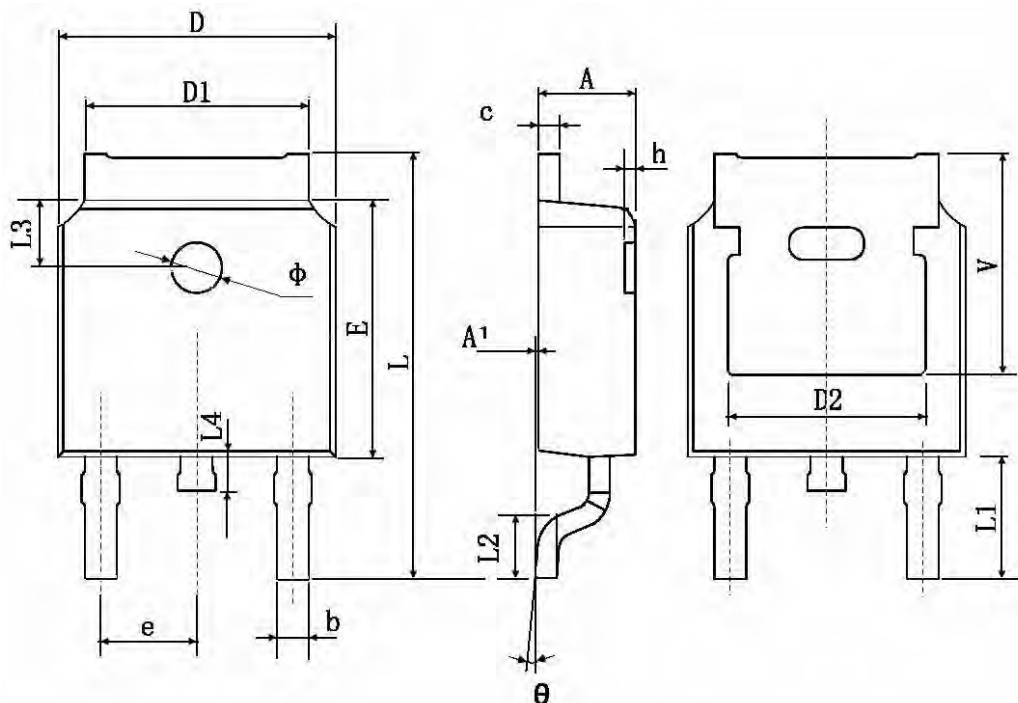


Fig.11 Unclamped Inductive Switching Waveform



## TO-252-2L(TO-252-2(DPAK)) Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 2.200                     | 2.400  | 0.087                | 0.094 |
| A1     | 0.000                     | 0.127  | 0.000                | 0.005 |
| b      | 0.660                     | 0.860  | 0.026                | 0.034 |
| c      | 0.460                     | 0.580  | 0.018                | 0.023 |
| D      | 6.500                     | 6.700  | 0.256                | 0.264 |
| D1     | 5.100                     | 5.460  | 0.201                | 0.215 |
| D2     | 0.483 TYP.                |        | 0.190 TYP.           |       |
| E      | 6.000                     | 6.200  | 0.236                | 0.244 |
| e      | 2.186                     | 2.386  | 0.086                | 0.094 |
| L      | 9.800                     | 10.400 | 0.386                | 0.409 |
| L1     | 2.900 TYP.                |        | 0.114 TYP.           |       |
| L2     | 1.400                     | 1.700  | 0.055                | 0.067 |
| L3     | 1.600 TYP.                |        | 0.063 TYP.           |       |
| L4     | 0.600                     | 1.000  | 0.024                | 0.039 |
| Φ      | 1.100                     | 1.300  | 0.043                | 0.051 |
| θ      | 0°                        | 8°     | 0°                   | 8°    |
| h      | 0.000                     | 0.300  | 0.000                | 0.012 |
| V      | 5.350 TYP.                |        | 0.211 TYP.           |       |



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